1N5908

1500 Watt Mosorb™ Zener Transient Voltage Suppressors

Unidirectional*

Mosorb devices are designed to protect voltage sensitive components from high voltage, high–energy transients. They have excellent clamping capability, high surge capability, low zener impedance and fast response time. These devices are ON Semiconductor's exclusive, cost-effective, highly reliable Surmetic™ axial leaded package and are ideally-suited for use in communication systems, numerical controls, process controls, medical equipment, business machines, power supplies and many other industrial/consumer applications, to protect CMOS, MOS and Bipolar integrated circuits.

Specification Features:

- Working Peak Reverse Voltage Range – 5 V
- Peak Power – 1500 Watts @ 1 ms
- Maximum Clamp Voltage @ Peak Pulse Current
- Low Leakage < 5 μA Above 10 V
- Response Time is Typically < 1 ns

Mechanical Characteristics:

CASE: Void-free, transfer-molded, thermosetting plastic
FINISH: All external surfaces are corrosion resistant and leads are readily solderable
MAXIMUM LEAD TEMPERATURE FOR SOLDERING PURPOSES: 230°C, 1/16″ from the case for 10 seconds
POLARITY: Cathode indicated by polarity band
MOUNTING POSITION: Any

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Power Dissipation (Note 1.) @ $T_L \le 25°C$	P_{PK}	1500	Watts
Steady State Power Dissipation @ $T_L \le 75°C$, Lead Length = 3/8″	P_D	5.0	Watts
Derated above $T_L = 75°C$		50	mW/°C
Thermal Resistance, Junction–to–Lead	$R_{\theta JL}$	20	°C/W
Forward Surge Current (Note 2.) @ $T_A = 25°C$	I_{FSM}	200	Amps
Operating and Storage Temperature Range	T_J, T_{stg}	– 65 to +175	°C

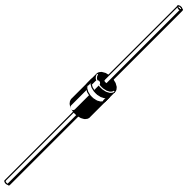
1. Nonrepetitive current pulse per Figure 4 and derated above $T_A = 25°C$ per Figure 2.
2. 1/2 sine wave (or equivalent square wave), PW = 8.3 ms, duty cycle = 4 pulses per minute maximum.

* Bidirectional device will not be available in this device

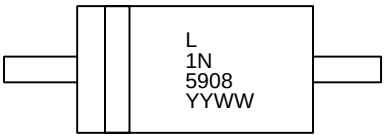
ON Semiconductor™

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AXIAL LEAD
CASE 41A
PLASTIC



L = Assembly Location
1N5908 = JEDEC Device Code
YY = Year
WW = Work Week

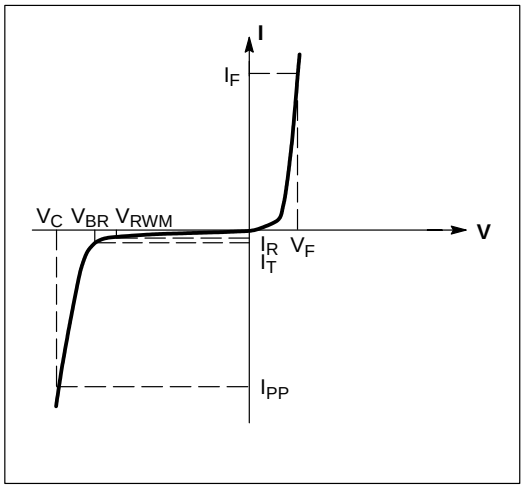
ORDERING INFORMATION

Device	Package	Shipping
1N5908	Axial Lead	500 Units/Box
1N5908RL4	Axial Lead	1500/Tape & Reel

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted, V_F = 3.5 V Max. @ I_F (Note 3.) = 100 A)

Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
I_F	Forward Current
V_F	Forward Voltage @ I_F



Uni–Directional TVS

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted, V_F = 3.5 V Max. @ I_F (Note 3.) = 53 A)

Device (Note 4.)	V_{RWM} (Note 5.) (Volts)	I_R @ V_{RWM} (μA)	Breakdown Voltage V_{BR} (Note 6.) (Volts) Min	Nom	Max	@ I_T (mA)	V_C (Volts) (Note 7.) @ I_{PP} = 120 A	@ I_{PP} = 60 A	@ I_{PP} = 30 A
1N5908	5.0	300	6.0	–	–	1.0	8.5	8.0	7.6

NOTES:
3. Square waveform, PW = 8.3 ms, Non–repetitive duty cycle.
4. 1N5908 is JEDEC registered as a unidirectional device only (no bidirectional option)
5. A transient suppressor is normally selected according to the maximum working peak reverse voltage (V_{RWM}), which should be equal to or greater than the dc or continuous peak operating voltage level.
6. V_{BR} measured at pulse test current I_T at an ambient temperature of 25°C and minimum voltages in V_{BR} are to be controlled.
7. Surge current waveform per Figure 4 and derate per Figure 2 of the General Data – 1500 W at the beginning of this group

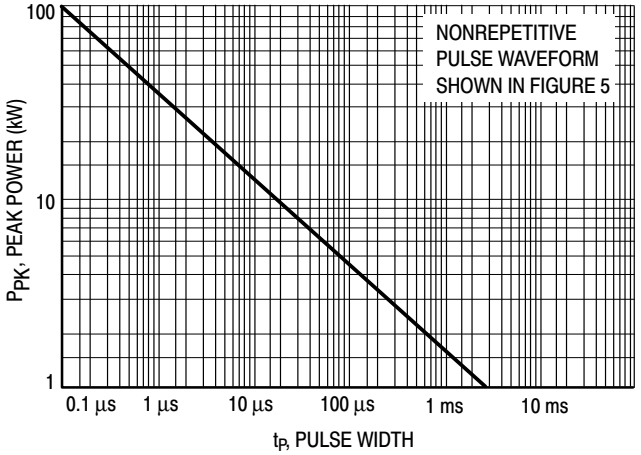


Figure 1. Pulse Rating Curve

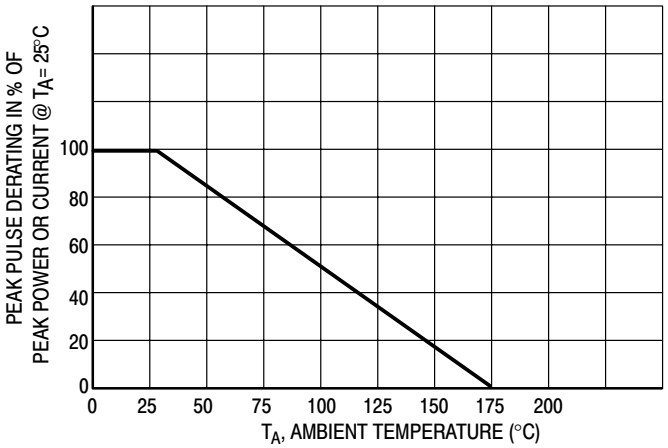


Figure 2. Pulse Derating Curve

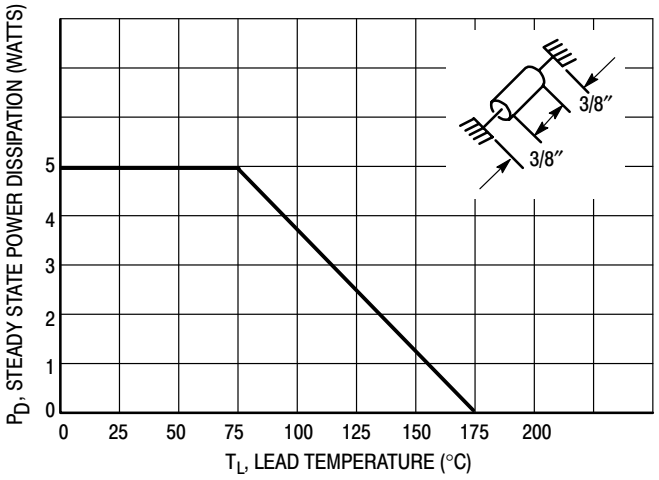


Figure 3. Steady State Power Derating

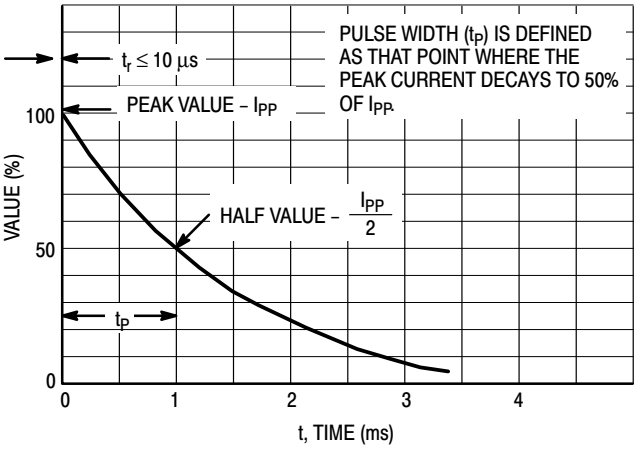


Figure 4. Pulse Waveform

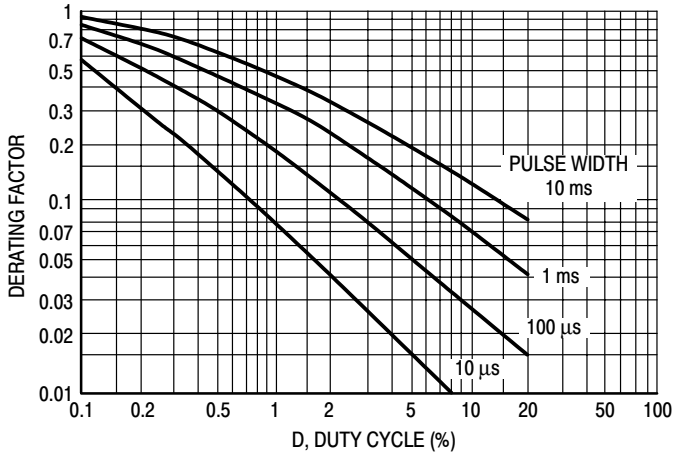


Figure 5. Typical Derating Factor for Duty Cycle

APPLICATION NOTES

RESPONSE TIME

In most applications, the transient suppressor device is placed in parallel with the equipment or component to be protected. In this situation, there is a time delay associated with the capacitance of the device and an overshoot condition associated with the inductance of the device and the inductance of the connection method. The capacitance effect is of minor importance in the parallel protection scheme because it only produces a time delay in the transition from the operating voltage to the clamp voltage as shown in Figure 6.

The inductive effects in the device are due to actual turn-on time (time required for the device to go from zero current to full current) and lead inductance. This inductive effect produces an overshoot in the voltage across the equipment or component being protected as shown in Figure 7. Minimizing this overshoot is very important in the application, since the main purpose for adding a transient suppressor is to clamp voltage spikes. These devices have excellent response time, typically in the picosecond range and negligible inductance. However, external inductive effects could produce unacceptable overshoot. Proper circuit layout, minimum lead lengths and placing the suppressor device as close as possible to the equipment or components to be protected will minimize this overshoot.

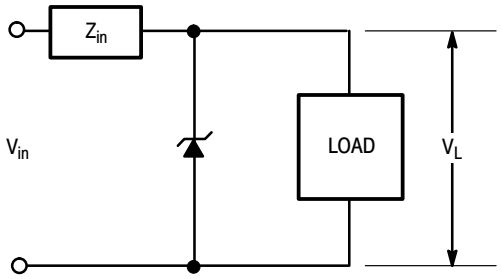
Some input impedance represented by Z_{in} is essential to prevent overstress of the protection device. This impedance should be as high as possible, without restricting the circuit operation.

DUTY CYCLE DERATING

The data of Figure 1 applies for non-repetitive conditions and at a lead temperature of 25°C. If the duty cycle increases, the peak power must be reduced as indicated by the curves of Figure 5. Average power must be derated as the lead or ambient temperature rises above 25°C. The average power derating curve normally given on data sheets may be normalized and used for this purpose.

At first glance the derating curves of Figure 5 appear to be in error as the 10 ms pulse has a higher derating factor than the 10 μs pulse. However, when the derating factor for a given pulse of Figure 5 is multiplied by the peak power value of Figure 1 for the same pulse, the results follow the expected trend.

TYPICAL PROTECTION CIRCUIT



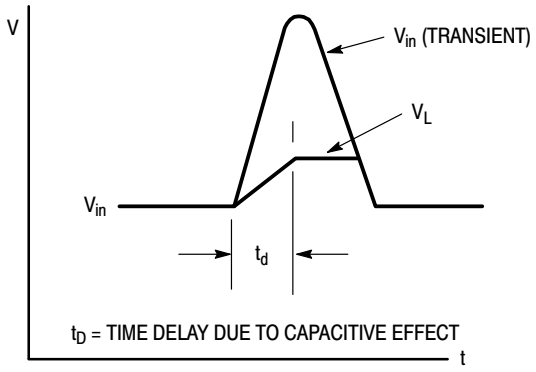


Figure 6.

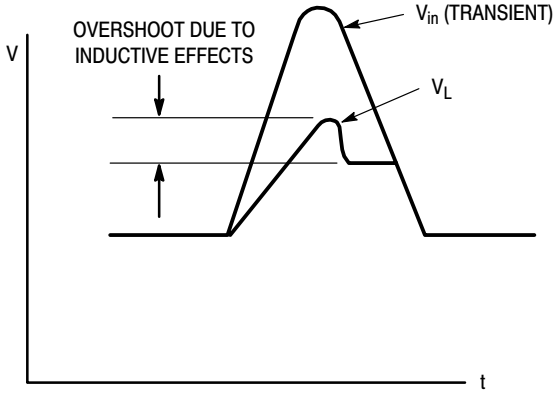


Figure 7.

CLIPPER BIDIRECTIONAL DEVICES

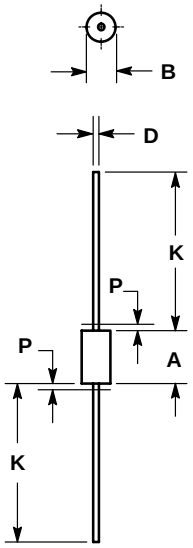
1. Clipper-bidirectional devices are available in the 1.5KEXXA series and are designated with a “CA” suffix; for example, 1.5KE18CA. Contact your nearest ON Semiconductor representative.
2. Clipper-bidirectional part numbers are tested in both directions to electrical parameters in preceeding table (except for V_F which does not apply).
3. The 1N6267A through 1N6303A series are JEDEC registered devices and the registration does not include a “CA” suffix. To order clipper-bidirectional devices one must add CA to the 1.5KE device title.

OUTLINE DIMENSIONS

Transient Voltage Suppressors – Axial Leaded

1500 Watt Mosorb

MOSORB
CASE 41A–04
ISSUE D



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. LEAD FINISH AND DIAMETER UNCONTROLLED IN DIMENSION P.
4. 041A–01 THRU 041A–03 OBSOLETE, NEW STANDARD 041A–04.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.335	0.374	8.50	9.50
B	0.189	0.209	4.80	5.30
D	0.038	0.042	0.96	1.06
K	1.000	---	25.40	---
P	---	0.050	---	1.27

Notes

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